	Serial or	Filing or	Inventor/
Docket Number	Patent Number	Issue Date	<u>Applicant</u>
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1	246909US90 DIV	10/746,081 -	12/29/03	HIRAMATSU, et al.
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<sup>\*</sup>Present Application; listed for information NFO/amr

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~	AA	6,507,006	1-14-2003	Hiramatsu et al.			ð m
1	AB	6,465,763	10-15-2002	Ito et al.			
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N	AY						
	AZ				Addi	tional Refe	rences sheet(s) attached
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*Examiner: In conformance	itial if ro	eference is considered, of considered. Include co	whether or not py of this form	citation is in conformance with MPEP 60 with next communication to applicant.	09; Draw lir	ne through	citation if not in



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	PER CLIENT	10/345,356	01/16/03	ITO
	PER CLIENT	09/787,954 <b>\</b>	03/23/01	ITO
	PER CLIENT	09/787,816 <b>\</b>	03/23/01	ÍΤΟ
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	PER CLIENT	09/806,957×	04/06/01	ITO et al.
	PER CLIENT	09/926,730 ×	04/16/01	HIRAMATSU et al.
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